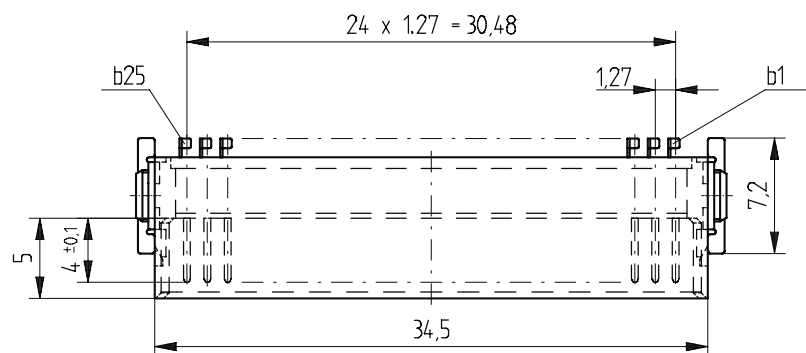
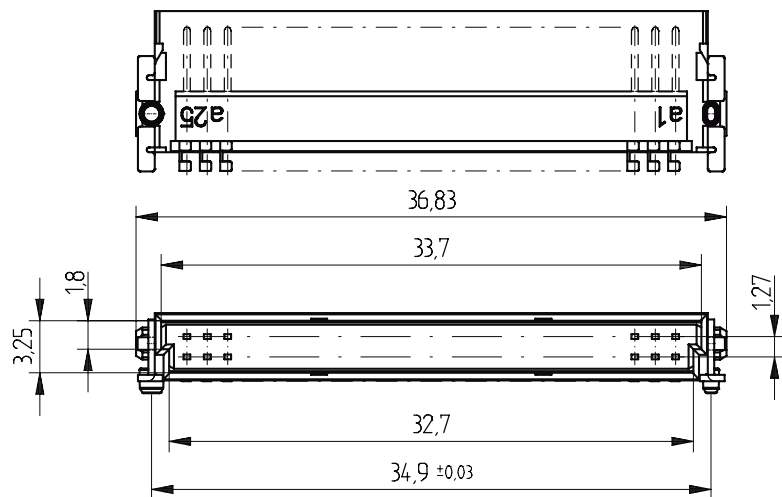
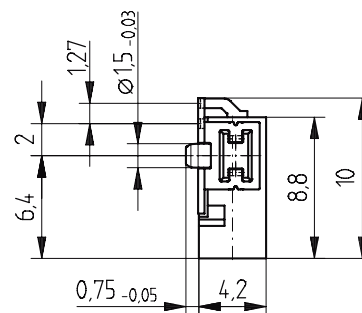
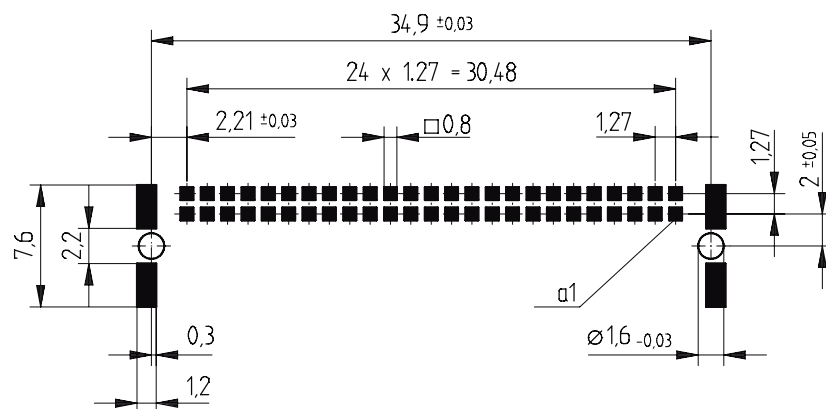




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



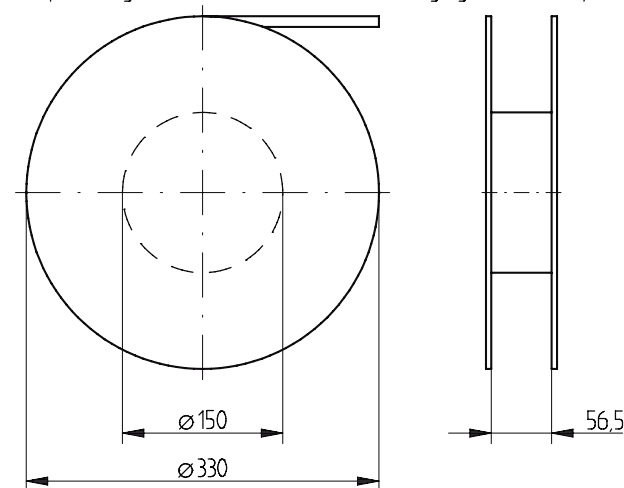
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

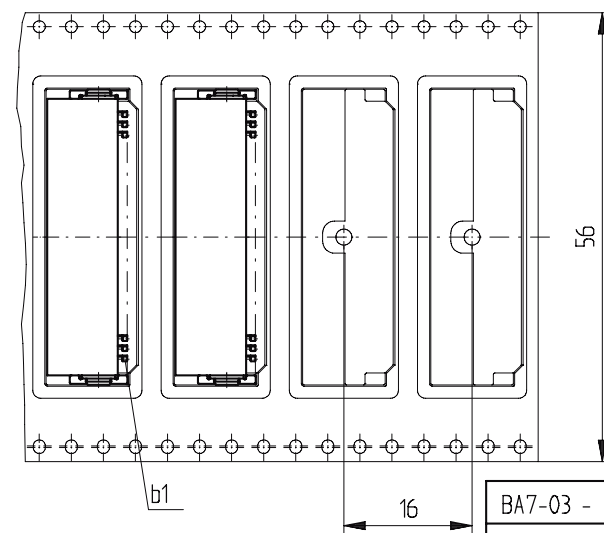
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt in Gurtverpackung - Tape on Reel Packaging
Verpackungseinheit: 560 Stück - Packaging unit: 560 pcs



Abspulrichtung - Reel off Direction



BA7-03 - Standard Bauhöhe

type7-03 - Standard Assembly Height

Information:	Tolerances	 All Dimensions in mm	Scale	3:1
			XXXXX Angaben zu entsprechender Ident-Nr. siehe Fertigungsunterlagen For further information about I.Q. number see manufacturing document.	
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			154765	I
b	30.11.2006			
Index	Date	V:00059969.SZA	SMCB	